

## Schottky Rectifier, 100 A

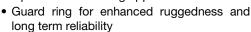


PowerTab<sup>®</sup>

PRODUCT SUMMARY				
Package	PowerTab <sup>®</sup>			
I <sub>F(AV)</sub>	100 A			
$V_{R}$	15 V			
V <sub>F</sub> at I <sub>F</sub>	0.45 V			
I <sub>RM</sub>	870 mA at 100 °C			
T <sub>J</sub> max.	125 °C			
Diode variation	Single die			
E <sub>AS</sub>	9 mJ			

#### **FEATURES**

- Ultralow forward voltage drop
- · Optimized for OR-ing applications





- · Screw mounting only
- Designed and qualified according to JEDEC-JESD47
- 125 °C max. operating junction temperature (V<sub>R</sub> < 5 V)
- High frequency operation
- Continuous high current operation
- PowerTab® package
- Compliant to RoHS Directive 2002/95/EC

#### **DESCRIPTION**

The VS-100BGQ015 Schottky rectifier has been optimized for ultralow forward voltage drop specifically for the OR-ing of parallel power supplies. The proprietary barrier technology allows for reliable operation up to 125 °C junction temperature. Typical applications are in parallel switching power supplies, converters, reverse battery protection, and redundant power subsystems.

MAJOR RATINGS AND CHARACTERISTICS				
SYMBOL	CHARACTERISTICS	VALUES	UNITS	
1	Rectangular waveform	100	А	
I <sub>F(AV)</sub>	T <sub>C</sub>	88	°C	
V <sub>RRM</sub>		15	V	
I <sub>FSM</sub>	t <sub>p</sub> = 5 μs sine	5000	А	
V	100 A <sub>pk</sub> (typical)	0.39	V	
$V_{F}$	TJ	125	°C	
TJ	Range	- 55 to 125	°C	

VOLTAGE RATINGS				
PARAMETER	SYMBOL	TEST CONDITIONS	VS-100BGQ015	UNITS
Maximum DC reverse veltage	V	T <sub>J</sub> = 100 °C	15	V
Maximum DC reverse voltage	$V_R$	T <sub>J</sub> = 125 °C	5	V

ABSOLUTE MAXIMUM RATINGS					
PARAMETER	SYMBOL	TEST CONDITIONS		VALUES	UNITS
Maximum average forward current	I <sub>F(AV)</sub>	50 % duty cycle at T <sub>C</sub> = 88 °C, rectangular waveform		100	Α
Maximum peak one cycle		5 µs sine or 3 µs rect. pulse	Following any rated load condition and with rated	5000	А
non-repetitive surge current	I <sub>FSM</sub>	10 ms sine or 6 ms rect. pulse	V <sub>RRM</sub> applied	1000	^
Non-repetitive avalanche energy	E <sub>AS</sub>	T <sub>J</sub> = 25 °C, I <sub>AS</sub> = 2 A, L = 4.5 mH		9	mJ
Repetitive avalanche current	I <sub>AR</sub>	Current decaying linearly to zero in 1 $\mu$ s  Frequency limited by $T_J$ maximum $V_A = 3 \times V_R$ typical		Α	



ELECTRICAL SPECIFICATIONS						
PARAMETER	SYMBOL	TEST CONDITIONS		TYP.	MAX.	UNITS
	) (1)	50 A	- T <sub>J</sub> = 25 °C	0.36	0.4	V
Forward voltage drop		100 A		0.45	0.52	
Forward voltage drop	V <sub>FM</sub> <sup>(1)</sup>	50 A	- T <sub>J</sub> = 125 °C	0.27	0.31	
		100 A		0.39	0.45	
		T <sub>J</sub> = 100 °C, V <sub>R</sub> = 12 V		480	700	mA
Maximum reverse leakage current	I <sub>RM</sub> <sup>(1)</sup>	$T_J = 125 ^{\circ}\text{C},  V_R = 5  \text{V}$		1	1.2	Α
waximum reverse leakage current	'RM '''	T <sub>J</sub> = 25 °C	- V <sub>R</sub> = Rated V <sub>R</sub>	7	18	mA
		T <sub>J</sub> = 100 °C		580	870	IIIA
Maximum junction capacitance	C <sub>T</sub>	$V_R = 5 V_{DC}$ , (test signal range 100 kHz to 1 MHz), 25 °C		38	00	pF
Typical series inductance	L <sub>S</sub>	Measured from tab to mounting plane		3.	.5	nH
Maximum voltage rate of change	dV/dt	Rated V <sub>R</sub>		10	000	V/µs

#### Note

 $^{(1)}\,$  Pulse width < 300 µs, duty cycle < 2 %

THERMAL - MEG	THERMAL - MECHANICAL SPECIFICATIONS					
PARAMETER		SYMBOL	TEST CONDITIONS	VALUES	UNITS	
Maximum junction tem range	perature	TJ		- 55 to 125	°C	
Maximum storage temp	erature range	T <sub>Stg</sub>		- 55 to 150		
Maximum thermal resis	tance,	R <sub>thJC</sub>	DC operation	0.50	°C/W	
Maximum thermal resis case to heatsink	tance,	R <sub>thCS</sub>	Mounting surface, smooth and greased	0.30		
Approximate weight				5	g	
Approximate weight				0.18	OZ.	
Maria Para Laura	minimum			1.2 (10)	N·m	
Mounting torque -	maximum			2.4 (20)	(lbf $\cdot$ in)	
Marking device			Case style PowerTab®	100BGQ015		



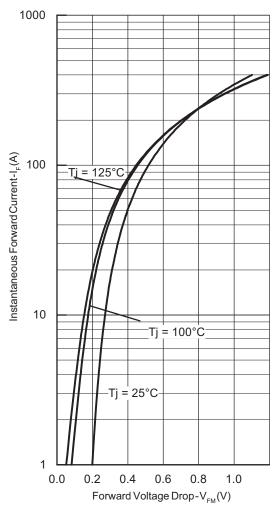


Fig. 1 - Maximum Forward Voltage Drop Characteristics

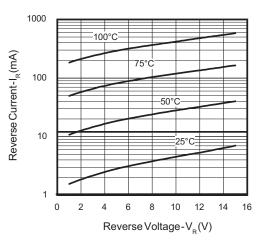


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage

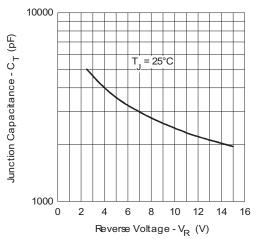


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

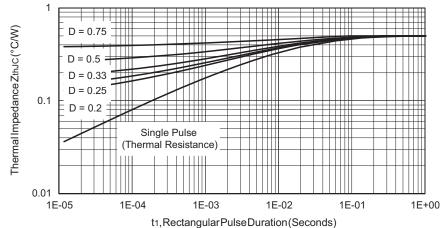


Fig. 4 - Maximum Thermal Impedance Z<sub>thJC</sub> Characteristics

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### Vishay Semiconductors

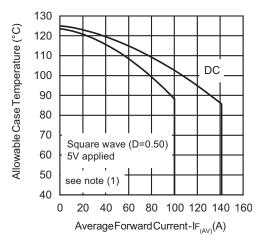


Fig. 5 - Maximum Allowable Case Temperature vs. Average Forward Current

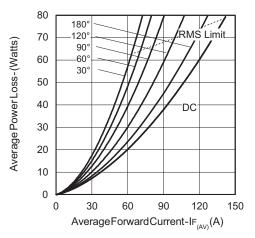


Fig. 6 - Forward Power Loss Characteristics

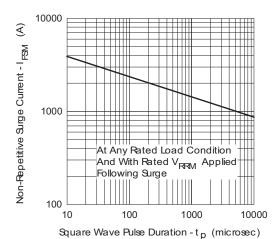


Fig. 7 - Maximum Non-Repetitive Surge Current

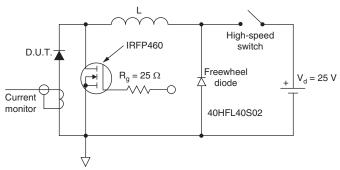


Fig. 8 - Unclamped Inductive Test Circuit

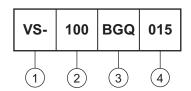
#### Note

 $^{(1)}$  Formula used:  $T_C = T_J$  - (Pd + Pd\_{REV}) x R<sub>thJC</sub>; Pd = Forward power loss =  $I_{F(AV)}$  x V<sub>FM</sub> at (I<sub>F(AV)</sub>/D) (see fig. 6); Pd\_{REV} = Inverse power loss = V\_{R1} x I<sub>R</sub> (1 - D); I<sub>R</sub> at V<sub>R1</sub> = 5 V



#### **ORDERING INFORMATION TABLE**

Device code



1 - Vishay Semiconductors product

2 - Current rating

Essential part number

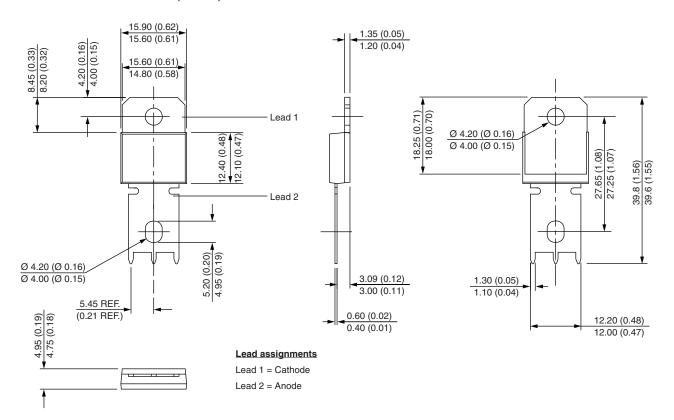
Voltage code = V<sub>RRM</sub>

LINKS TO RELATED DOCUMENTS				
Dimensions www.vishay.com/doc?95240				
Part marking information	www.vishay.com/doc?95370			
SPICE model	www.vishay.com/doc?95428			
Application note	www.vishay.com/doc?95179			



### PowerTab®

#### **DIMENSIONS** in millimeters (inches)







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